SN54145, SN54LS145, SN74145, SN74LS145 BCD-TO-DECIMAL DECODERS/DRIVERS

SDLS051

MARCH 1974 - REVISED MARCH 1988

FOR USE AS LAMP, RELAY, OR MOS DRIVERS

- Full Decoding of Input Logic
- SN54145, SN74145, and SN74LS145 Have 80-mA Sink-Current Capability
- All Outputs Are Off for Invalid BCD Input Conditions
- Low Power Dissipation of 'LS145 ...
 35 mW Typical

FUNCTION	TABLE

<u> </u>														
NO.		INP	UTS					0	ΨT	PUT	S			
	D	C	8	Α	0	1	2	3	4	5	6	7	8	9
0	L	L	L	L	L	н	Н	н	Н	Н	н	Н	Н	Н
1	L	L	L	н	H	L	Н	н	Н	Н	н	н	н	н
2	L.	L.	н	L	н	н	L	н	Н	н	н	н	н	н
3	L	L	н	н	н	н	Н	L	н	н	н	н	н	н
4	Ł	н	L	L	н	н	Н	Н	L	Н	н	Н	Н	Н
5	Ł	н	L	Η	н	н	н	н	н	L	н	н	н	I
6	L	н	н	L	н	н	н	н	н	н	Ł	н	н	н
7	L	н	н	н	н	н	н	н	н	н	н	L	Н	н
8	н	L	L	L	н	н	н	н	н	н	н	н	L	н
9	н	L	L	н	н	н	Н	н	н	н	Н	Н	н	L
	Н	٦L	Н	L	н	H	Н	Н	Н	н	Н	Н	Н	Η
	н	L	н	н	н	н	н	н	н	н	н	Н	н	н
Ē	н	н	L	L	н	н	н	н	н	н	н	н	н	н
INVALID	н	н	L	н	н	н	н	н	н	н	н	н	н	н
=	н	Н	н	L	н	н	н	н	н	н	н	н	н	н
	н	н	н	н	н	н	н	н	н	н	н	н	н	н

H = high level (off), L = low level (on)

description

These monolithic BCD-to-decimal decoder/drivers consist of eight inverters and ten four-input NAND gates. The inverters are connected in pairs to make BCD input data available for decoding by the NAND gates. Full decoding of valid BCD input logic ensures that all outputs remain off for all invalid binary input conditions. These decoders feature high-performance, n-p-n output transistors designed for use as indicator/relay drivers or as open-collector logic-circuit drivers. Each of the highbreakdown output transistors (15 volts) of the SN54145, SN74145, or SN74LS145 will sink up to 80 milliamperes of current. Each input is one Series 54/74 or Series 54LS/74LS standard load, respectively. Inputs and outputs are entirely compatible for use with TTL or DTL logic circuits, and the outputs are compatible for interfacing with most MOS integrated circuits. Power dissipation is typically 215 milliwatts for the '145 and 35 milliwatts for the 'LS145.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.







NC - No internal connection

logic diagram



Pin numbers shown are for D, J, N. and W packages.



SN54LS145, SN74LS145 **BCD-TO-DECIMAL DECODERS/DRIVERS**

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_CC (see Note 1)
Input voltage , , , , , , , , , , , , , , , , , , ,
Maximum current into any output (off-state)
Operating free-air temperature range: SN54145
SN74145
Storage temperature range \dots

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54145			SN74145		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V
Off-state output voltage, VO(off)			15			15	V
Operating free-air temperature, T _A	-55		125	0		70	° C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDIT	MIN	TYPİ	ΜΑΧ	UNIT	
VIH	High-level input voltage			2			V
V _{IL}	Low-level input voltage					0.8	V
Vik	Input clamp voltage	V _{CC} = MIN, I _l = -12 mA				-1.5	V
IO(off)	Otf-state output current	$V_{CC} = MIN, V_{IH} = 2 V,$ $V_{IL} = 0.8 V, V_{O(off)} = 15$			250	μA	
VOion)	On-state output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V	1 _{O(on)} = 80 mA 1 _{O(on)} = 20 mA		0.5	0.9 0.4	v
1	Input current at maximum input voltage	VCC = MAX, VI = 5.5 V		-		1	mA
Ιн	High-level input current	V _{CC} = MAX, V ₁ = 2.4 V				40	μA
<u>۱</u> ι	Low-level input current	V _{CC} = MAX, V ₁ = 0.4 V	·····			-1.6	mA
100	Supply current	Ver - MAX - See New 7	SN54145		43	62	
lec	Supply current	V _{CC} = MAX, See Note 2	SN74145		43	70	mΑ

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. [‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25$ °C. NOTE 2: I_{CC} is measured with all inputs grounded and outputs open.

switching characteristics, V_{CC} = 5 V, T_A = 25 $^{\circ}$ C

PARAMETER		TEST CON	MIN	MAX	UNIT	
^t PLH	Propagation delay time, low-to-high-level output	$C_1 = 15 pF_2 R_1 = 100$	Ω. See Note 3		50	ns
TPHL	Propagation delay time, high-to-low-level output		32, See NOTE S		50	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs





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SN54145, SN74145 **BCD-TO-DECIMAL DECODERS/DRIVERS**

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	· · <i>·</i> · · · · · · · · · · · · · · · ·	
	· · · · · · · · · · · · · · · · · · ·	
Storage temperature range	· · · · · · · · · · · · · · · · · · - 6	5°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	Sr	V54LS1	45	SN74LS145			1
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V
Off-state output voltage, VO(off)			15			15	V
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST COM	TEST CONDITIONS [†]			45	SN74LS145			
			MIN TYPİ		MAX	MIN	TYP‡	MAX	UNIT	
⊻ін	High-level input voltage			2			2			V
VIL	Low-level input voltage					0.7	†		0.8	V
VIK	Input clamp voltage	V _{CC} = MIN,	lı = -18 mA			-1.5	-		-1.5	V
IO(off)	Off-state output current	V _{CC} ≠ MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, V _{OH} = 15 V			250			250	μА
V _{O(on)}	On-state output voltage	V _{CC} ∸ MIN, V _{IH} ≈ 2 V,	I _{OL} = 12 mA	L	0,25	0.4		0.25 0.35	0.4 0.5	v
		V _{IL} = V _{IL} max	I _{OL} = 80 mA					2.3	3	
-μ	Input current at maximum input voltage	VCC = MAX,	V = 7 V			0.1			0.1	mA
Чн	High-level input current	V _{CC} = MAX,	VI = 2.7 V			20			20	μA
ΠL	Law-level input current	V _{CC} = MAX,	VI = 0.4 V			-0.4			-0.4	mA
'cc	Supply current	V _{CC} = MAX,	See Note 2		7	13		7	13	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. $\frac{1}{2}$ All typical values are at V_{CC} = 5 V, T_A = 25°C. NOTE 2: 1_{CC} is measured with all inputs grounded and outputs open.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER		TEST CONDITI	IONS	MIN P	MAX	UNIT
tPLH Propagation delay time, iow-to-high-level output	C) = 45 pF,	B 665 O	See Note 3		50	ns
tPHL Propagation delay time, high-to-low-level output	сц - 45 рг,	R _L = 665 Ω,	See Note S		50	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

schematic of inputs and outputs







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